

SCRR0508WD Series Current Sensing Resistor (Lead / Halogen Free)

The history of revision change for the specification

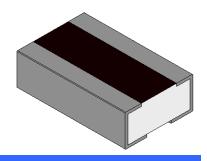
Date	Revision	Changes	
2017/8/23	A0	New Approval	
2018/01/02	A1	Update L&W size	
2019/09/05	A2	Update resistance range, TCR, chip Size and Land Pattern	
2020/03/11	А3	Update the max of resistance	
2020/08/10	A4	Add Resistance Tolerance	
2023/08/16	A5	Update pand pattern & reliability SPEC.	



SCRR0508WD Series Current Sensing Resistor (Lead / Halogen Free)

Features / Applications :

- High power rating is up to 1/2W
- Low TCR ($\pm 200 \text{ ppm/}^{\circ}\text{C}$)
- Current sensing resistor for power supplies, motor circuits, etc.
- Suitable for reflow soldering
- Excellent heat dissipation by wide terminal type

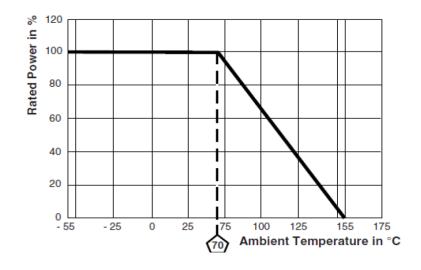


Electrical Specifications:

Characteristics	Feature		
Power Rating*	1/2 W		
Resistance Range	$0.02\Omega{\sim}{<}0.03\Omega$	$0.03\Omega{\sim}0.51\Omega$	
Temperature Coefficient of Resistance(ppm/°C)	±200		
Resistance Tolerance	±1%(F), ±2%(G), ±5%(J)	±0.5%(D), ±1%(F), ±2%(G), ±5%(J)	
Operation Temperature Range	-55°C ∼ +155°C		

*Note:

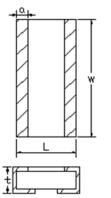
For sensor operated at ambient temperature in excess of 70°C, the maximum load shall be derated in accordance with the following curve.

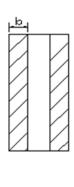


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Outline Drawing:







L	1.25 ± 0.20	
W	2.00 ± 0.20	
t	0.60 ± 0.20	
а	0.30 ± 0.20	
b	0.40 ± 0.20	

Unit: mm

Type Designation:

SCRR 0508 W D - - - -

(1) (2) (3) (4) - (5) (6)

Note:

(1) Series No.

(2) Size

(3) Terminal type : W = Wide terminal

(4) Power Rating : D = 1/2W

(5) Resistance value:

The "R" shall be used as a decimal point, For example --

 $R020 = 0.02\Omega$;

(6) Tolerance (%)

D=±0.5%, F=±1%, G=±2%, J=±5%

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Characteristics:

Electrical

Item	Specification and Requirement	Test Method	
Temperature	As electrical specifications	JIS-C-5201	
Coefficient of		Room temperature	
Resistance (TCR)		Room temperature+100 $^{\circ}$ C	
Short Time Overload	△R: ± 0.5%	JIS-C-5201-1 4.13	
	Without damage by flashover, spark,	2.5 x rated power for 5 seconds.	
	arcing, burning or breakdown		
Insulation Resistance	Over 100 M Ω on Overcoat layer face up	JIS-C-5201-1 4.6	
	Over 1,000 M Ω on Substrate side face up	100V _{DC} for 60 +10/-0 seconds.	
Voltage Proof	△R: ± 1.0%	JIS-C-5201-1 4.7	
	Without damage by flashover, spark,	400V _{AC} (rms.) for 60 +10/-0 seconds.	
	arcing, burning or breakdown		
ESD	△R: ± 1.0%	AEC-Q200-002	
		Human body, 3KV.	

Mechanical

Item	Specification and Requirement	Test Method	
Solderability	The surface of terminal immersed shall be JIS-C-5201-1 4.17		
	minimum of 95% covered with a new	245 ± 5 °C for 3 ± 0.5 seconds.	
	coating of solder		
Resistance to Solder	△R: ± 1.0%	JIS-C-5201-1 4.18	
Heat	Without distinct deformation in	260 ± 5°C for 10 ± 1 seconds.	
	appearance		
Bending Test	△R: ± 1.0%	AEC-Q200-005	
	Without mechanical damage such as	Bending value: 2 mm for 60 ± 1	
	break	seconds.	
Resistance to solvent	Without mechanical and distinct damage	MIL-STD-202 Method 215	
	in appearance	Add Aqueous wash chemical- OKEM	
		Clean or equivalent.	
		Do not use banned solvents.	

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Item	Specification and Requirement	Test Method	
Vibration	△R: ± 0.5% Without mechanical damage such as break	MIL-STD-202 Method 204 5g's for 20 minutes, 12 cycles each of 3 orientations. Test from 10-2000Hz.	
Mechanical Shock	△R: ± 0.5% Without mechanical damage such as break	MIL-STD-202 Method 213 100g's peak value, 6ms, Half-sine waveform, 12.3ft/sec.	
Terminal Strength (SMD)	No visible damage	JIS-C-5201-1 Force of 1.8Kg for 60 seconds.	

Endurance

Item	Specification and Requirement	Test Method	
Temperature Cycling	△R: ± 1.0%	MIL-STD-002 Method 107	
	Without distinct damage in appearance	1000 cycles, (-55°C~155°C)	
		30min maximum dwell time at each	
		temperature.	
Biased Humidity	△R: ± 1.0%	MIL-STD-202 Method 103	
		1000 hours, 85°C/85%R.H,	
		applied for 10% rated power	
		Measurement at 24 ± 4 hours after test	
		conclusion.	
Damp heat,	△R: ± 1.0%	IEC 60068-2	
steady state		(40 ± 2) °C; (93 ± 3) % RH;56 days.	
Load Life	△R: ± 2.0%	MIL-STD-202 Method 108	
	Without distinct	70°C, applied for 100% rated power	
	damage in appearance	1.5 Hour ON, 0.5 Hour OFF For total	
		1000 hours.	
High Temperature	△R: ± 1.0%	MIL-STD-202 Method 108	
Store	Without distinct	155°C for total 1,000 hours.	
	damage in appearance		

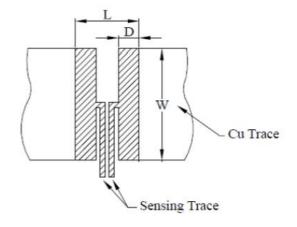
Note: Measurement at 24±4 hours after test conclusion for all reliability tests-parts.

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Recommend Land Pattern Dimensions:

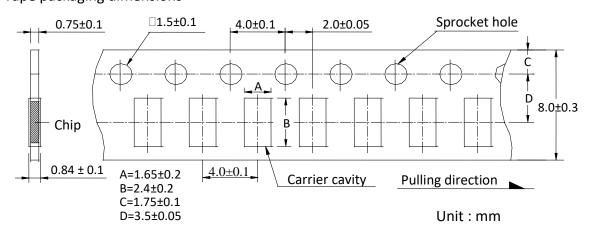


Size	W	L	D	t
	(mm)	(mm)	(mm)	(mm)
1220W	2.0	2.2	0.8	1.05

t: Copper foil minimum thickness of PCB

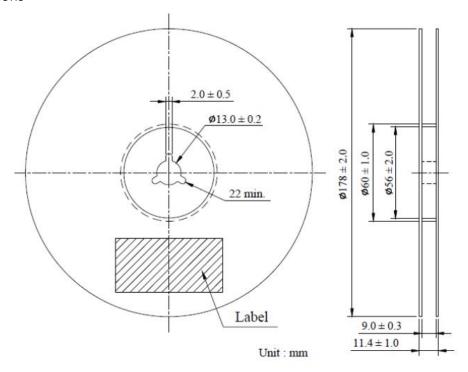
Packaging:

Tape packaging dimensions



Remark: Leader tape length≥30 cm(150 Hollow carrier cavity)

Reel dimensions



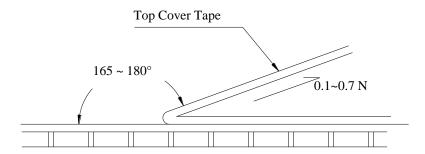
Numbers of Taping: 5,000 pieces /reel

The following items shall be marked on the reel.

- (1) Type designation.
- (2) Quantity
- (3) Manufacturing date code
- (4) Manufacturer's name

Peel force of top cover tape

The peel speed shall be about 300 mm/min. The peel force of top cover tape shall be between 0.1 to 0.7 N.





Care Note:

Care note for storage

- (1) Chip resistor shall be stored in a room where temperature and humidity must be controlled. (temperature 5 to 35°C, humidity 45 to 85% RH) However, a humidity keep it low, as it is possible.
- (2) Chip resistor shall be stored as direct sunshine doesn't hit on it.
- (3) Chip resistor shall be stored with no moisture, dust, a material that will make solderability inferior, and a harmful gas (Chloridation hydrogen, sulfurous acid gas, and sulfuration hydrogen).

Care note for operating and handling

- (1) It is necessary to protect the edge and protection coat of resistors from mechanical stress.
- (2) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (3) Resistors shall be used with in rated range shown in specification. Especially, if voltage more than specified value will be loaded to resistor, there is a case it will make damage for machine because of temperature rise depending on generating of heat, and increase resistance value or breaks.
- (4) In case that resistor is loaded a rated voltage, it is necessary to confirms temperature of a resistor and to reduce a load power according to load reduction curve, because a temperature rise of a resistor depends on influence of heat from mounting density and neighboring element.
- (5) Observe Limiting element voltage and maximum overload voltage specified in each specification
- (6) If there is possibility that a large voltage (pulse voltage, shock voltage) charge to resistor, it is necessary that operating condition shall be set up before use.

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